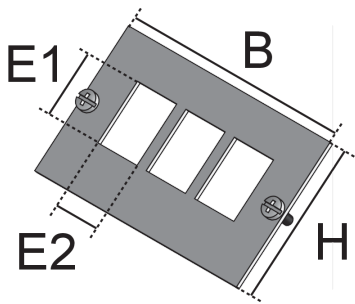


UDEP AMP SL

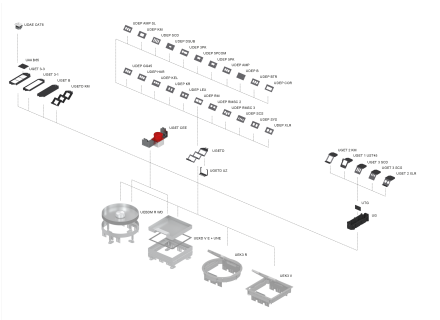
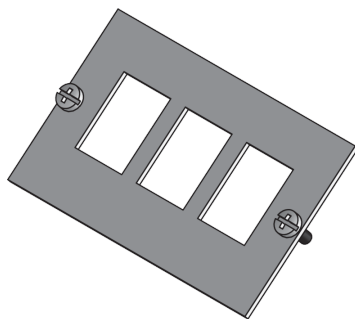
Mounting board, data technology



UDEP AMP SL components are installation boards from the underfloor system range. The boards are bolted into data device carriers and are used to accommodate up to 3 AMP-TWIST 7AS SL or AMP-TWIST 7AS SL data jacks from TE Connectivity. The installation boards are made of aluminium with a black coating on one side and have the installation dimensions of E1 20.25 mm and E2 14.78 mm.

Artikel	Typ	H	B	data jacks	E1	E2	colour	W
UDEP-AMP SL3	adapter board,	46 mm	75 mm	3	20.25 mm	14.78 mm	black	0.014 kg

DETAIL- UND ANWENDUNGSBILDER



OPTIONALES ZUBEHÖR

UGETD

